WIMA SMD-PET/VT



Metallized Polyester (PET) SMD Film Capacitors with Box Encapsulation

Special Features

- Size codes 4036, 5045 and 6560 with PET and encapsulated
- Operating temperature up to 100°C
- Self-healing
- According to RoHS 2002/95/EC *

Typical Applications

For general DC-applications e.g.

- By-pass
- **■** Blocking
- Coupling and decoupling
- Timing

Construction

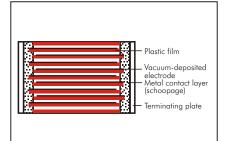
Dielectric:

Polyethylene-terephthalate (PET) film

Capacitor electrodes:

Vacuum-deposited

Internal construction:



Encapsulation:

Solvent-resistant, flame-retardent plastic case, UL 94 V-0, with epoxy resin seal.

Terminations:

Tinned plates.

Marking:

Colour: Black. Marking: Silver.

Electrical Data

Capacitance range:

0.01 μ F to 6.8 μ F

Rated voltages:

40 VDC, 63 VDC, 100 VDC, 250 VDC, 400 VDC, 630 VDC, 1000 VDC

Capacitance tolerances:

 $\pm 20\%$, $\pm 10\%$, ($\pm 5\%$ available subject to special enquiry)

Operating temperature range:

 -55° C to $+100^{\circ}$ C

Climatic test category:

55/100/56 in accordance with IEC

Insulation resistance at $+20^{\circ}$ C:

Test voltage:

1.6 U_r, 2 sec.

Voltage derating:

A voltage derating factor of 1.25 % per K must be applied from +85° C for DC voltages and from +75° C for AC voltages

Reliability:

Operational life > 300 000 hours Failure rate < 2 fit (0.5 x U_r and 40° C)

U _r	U _{test}	C ≤ 0.33 μF	0.33 μF < C ≤ 6.8 μF
40 VDC 63 VDC 100 VDC	10 V 50 V 100 V	$\geqslant 3.75 \times 10^3 \text{ M}\Omega$ (mean value: $1 \times 10^4 \text{ M}\Omega$)	≥ 1250 sec (MΩ × μF) (mean value: 3000 sec)
≥250 VDC	100 V	$\geq 1 \times 10^4 M\Omega$ (mean value: $5 \times 10^4 M\Omega$)	≥ 3000 sec (MΩ × μF) (mean value: 10 000 sec)

Measuring time: 1 min.

Dissipation factor at $+20^{\circ}$ C: tan δ

at f	C ≤ 0.1 μF	$0.1 \mu\text{F} < C \le 1.0 \mu\text{F}$	C > 1.0 μF
1 kHz	$\leq 8 \times 10^{-3}$	≤ 8 x 10 ⁻³	≤ 10 x 10 ⁻³
10 kHz	$\leq 15 \times 10^{-3}$	≤ 15 x 10 ⁻³	-
100 kHz	$\leq 30 \times 10^{-3}$	-	-

Maximum pulse rise time: for pulses equal to the rated voltage

Capacitance μ F	40VDC	63VDC	max	rise time V a. operation 250VDC		630VDC	1000VDC
0.01 0.022 0.033 0.068 0.1 0.22 0.33 0.68 1.0 2.2 3.3 6.8		- - - 3.5/35 3/30	- 10/100 6/60 4/40 3/30	- 12/120 9/90 7/70 -	- 21/210 14/140 10/100 - -	40/400 25/250 17/170 - -	50/500 32/320 - - - -

Dip Solder Test/Processing

Resistance to soldering heat:

Test Tb in accordance with DIN IEC 60068-2-20/EN 132 200.

Soldering bath temperature max. 260° C. Soldering duration max. 5 sec. Change in capacitance $\Delta C/C < 5$ %.

Soldering process:

Wave soldering and re-flow soldering.

Packing

Available taped and reeled in 12 mm blister pack.

Detailed taping information and graphs see WIMA main catalogue 2004.

^{*} as of Mai 2006

WIMA SMD-PET/VT



Continuation

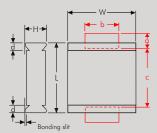
General Data

Сарас-	40 VDC/2		63 VDC/40										1000 VDC/40	00 VAC* H
itance	Size Code	±0.3	Size Code	±0.3	Size Code	±0.3	Size Code	±0.3	Size Code	H ±0.3	Size Code	H ±0.3	Size Code	±0.3
0.01 μ F 0.015 " 0.022 " 0.033 " 0.047 " 0.068 "									4036 4036	5.5 5.5	4036 4036 5045 5045 5045 6560	5.5 5.5 6.5 6.5 6.5 7.0	5045 5045 6560 6560 6560	6.5 6.5 7.0 7.0 7.0
0.1 µF 0.15 " 0.22 " 0.33 " 0.47 " 0.68 "					4036 4036 5045 5045	5.5 5.5 6.5 6.5	4036 4036 5045 5045 6560 6560	5.5 5.5 6.5 6.5 7.0 7.0	5045 5045 6560 6560 6560	6.5 6.5 7.0 7.0 7.0	6560 6560	7.0 7.0		
1.0 µF 1.5 " 2.2 " 3.3 " 4.7 " 6.8 "	4036 4036 5045 6560	5.5 5.5 6.5 7.0	4036 4036 5045 5045 6560	5.5 5.5 6.5 6.5 7.0	5045 6560 6560 6560	6.5 7.0 7.0 7.0	6560	7.0						

^{*}AC voltage: f = 50 Hz; 1.4 x U_{rms} + UDC $\leq U_{r}$

Dims. in mm.

Taped version see main catalogue 2004.



Solder pad recommendation.

Size code	L ±0.3	W ±0.3	d	a min.	b min.	c max.
4036	10.2	9.1	0.5	2.5	6 6	9
5045	12.7	11.2	0.7	2.5		11.5
6560	16.5	15	0.7	2.5		15

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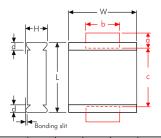
Recommendation for Processing — and Application for SMD Capacitors



Layout Form

The components can generally be positioned on the carrier material as desired. In order to prevent soldering shadows or ensure regular temperature distribution, extreme concentration of the components should be avoided. In practice, it has proven best to keep a minimum distance of the soldering surfaces between two WIMA SMDs of twice the height of the components.

Solder Pad Recommendation



Size Code	L ±0.3	W ±0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
4036	10.2	9.1	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
5045	12.7	11.5	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14
6560	16.5	15	0.7	2.5	6	15

The solder pad size recommendations given for each individual series are to be understood as minimum dimensions which can at any time be adjusted to the layout form.

Processing

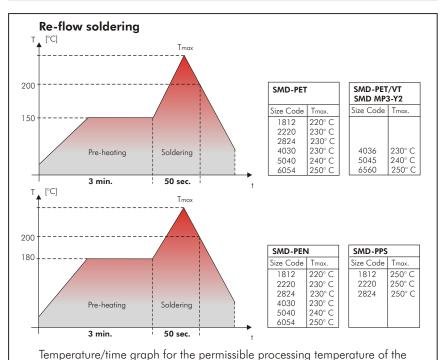
The processing of SMD components

- assembling
- soldering
- washing
- electrical final inspection/ calibrating

must be regarded as a complete process. The soldering of the printed circuit board, for example, can constitute considerable stress on all the electronic components.

The manufacturer's instructions on the processing of the components are mandatory.

Soldering Process



WIMA SMD film capacitor for typical convection soldering processes.

Due to the diverse procedures and the varying heat requirements of the different types of components, an exact processing temperature for reflow soldering processes cannot be specified. The graph is to be understood as a recommendation when

establishing the solder profile according to your actual requirements.

A max. temperature of T=210° C inside the component should not be exceeded when processing WIMA SMD capacitors.

SMD Handsoldering

WIMA SMD capacitors with plastic film dielectric are generally suitable for hand-soldering with a soldering iron where, however, similar to automated soldering processes, a certain duration and temperature should not be exceeded. These parameters are dependent on the physical size of the components and the relevant heat absorption involved.

The below data are to be regarded as guideline values and should serve to avoid damage to the dielectric caused by excessive heat during the soldering process. The soldering quality depends on the tool used and on the skill and experience of the person with the soldering iron in hand.

Size Code	Temperature °C / °F	Time duration
1812 2220 2824 4030/4036 5040/5045	225/437 225/437 250/482 260/500 260/500	2 sec tab 1 / 5 sec off / 2 sec tab 2 2 sec tab 1 / 5 sec off / 2 sec tab 2 2 sec tab 1 / 5 sec off / 2 sec tab 2 5 sec tab 1 / 5 sec off / 5 sec tab 2 5 sec tab 1 / 5 sec off / 5 sec tab 2
6054/6560	260/500	5 sec tab 1 / 5 sec off / 5 sec tab 2



Solder Paste

To obtain the best soldering performance we suggest the use of following solder past alloy:

Lead free solder paste

Sn - Bi

Sn - Zn (Bi)

Sn - Ag - Cu (recommended)

Solder paste with lead

Sn - Pb - Ag (Sn60-Pb40-A, Sn63-Pb37-A)

Washing

Basically, all plastic encapsuled components, irrespective of the brand cannot be considered as being hermetically sealed. They are therefore only suitable for industrial washing processes to a limited extent. During the washing process, washing agents can penetrate the interior of the component by capillary action through microcracks which might have occured. This is dependent on a number of parameters e.g.

- washing agents
- viscosity of the washing solvent
- temperature/time of the washing process
- mechanical washing aids such as ultrasonic water pressure rinsing and spraying pressure

The type of washing agent to be used is largely specific to the individual user or is often laid down by the manufacturer of the washing equipment. The agressiveness of the washing agent to be used can thus only be judged in appropriate test series relating to each individual washing process. By and large, the basic rule is that the washing process should be carried out as gently as possible.

Drying

During the washing process, aqueous solutions can penetrate the component. This can lead to changes in the electrical parameters. Suitable drying measures should ensure that no residual moisture or traces of washing substances are left in the component.

Initial Operation/Calibration

Due to the stress which the component are subjected to during processing, reversible parameter changes occur in almost all electronic components. The capacitance recovery accuracy to be expected with careful processing is within a scope of

 $|\Delta C/C| \leq 5\%$

For the initial operation of the device a minimum storage time of

 $t \ge 24 \text{ hours}$

is to be taken into account. With calibrated devices or when the application is largely dependent on capacitance it is advisable to prolong the storage time to

 $t \ge 10 \text{ days}$

In this way ageing effects of the capacitor structure can be anticipated. Parameter changes due to processing are not to be expected after this period of time.

Humidity Protection Bags

Taped WIMA SMD capacitors are shipped in humidity protection bags according to JEDEC standard, level 1 (EMI/static-shielding bags conforming to MIL-B 81705, Type 1, Class 1). Under controlled conditions the components can be stored two years and more in the originally sealed bag. Opened packing units should be consumed instantly or resealed for specific storage under controlled conditions...

Reliability

Taking account of the manufacturer's guidelines and compatible processing, the WIMA SMD stand out for the same high quality and reliability as the analogous leaded WIMA series. The technology of metallized film capacitors used e.g. in WIMA SMD-PEN achieves the best values for all fields of application. The expected value is about:

 $\lambda_0 \le 2$ fit

Furthermore the production of all WIMA components is subject to the regulations laid down by ISO 9000 as well as the guidelines for component specifications set out by IEC quality assessment systems for electronic components (IECQ-CECC).

Electrical Characteristics and Fields of Application

Basically the WIMA SMD series have the same electrical characteristics as the analogous leaded WIMA capacitors. Compared to ceramic or tantalum dielectrics WIMA SMD capacitors have a number of other outstanding qualities:

- favorable pulse rise time
- low ESR
- low dielectric absorption
- available in high voltage series
- large capacitance spectrum
- stand up to high mechanical stress
- good long term stability

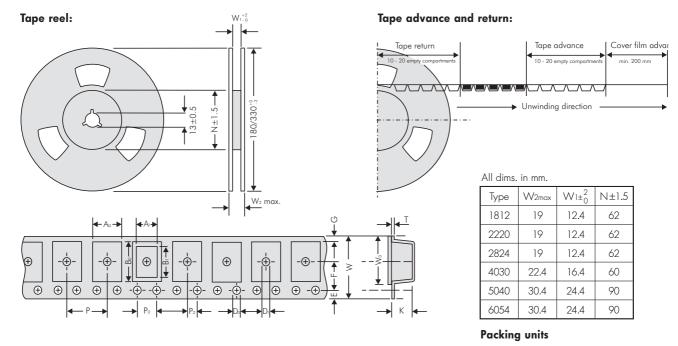
As regards technical performance as well as quality and reliability, the WIMA SMD series offer the possibility to cover nearly all applications of conventionally leaded film capacitors with SMD components. Furthermore, the WIMA SMD series can now be used for all the demanding capacitor applications for which, in the past, the use of leaded components was mandatory:

- measuring techniques
- oscillator circuits
- differentiating and integrating circuits
- A/D or D/A transformers
- sample and hold circuits
- automotive electronics

With the WIMA SMD programme available today, the major part of all plastic film capacitors can be replaced by WIMA SMD components. The field of application ranges from standard coupling capacitors to use in switch-mode power supplies as filter or charging capacitors with high voltage and capacitance values, as well as in telecommunications e.g. the well-known telephone capacitor $1\mu F/250VDC$.

Blister Tape Packaging and Packing Units of the WIMA SMD Capacitors





SMD 1812	A0 ±0.1	Αı	Bo ±0.1	Ві	Do +0.1	D ₁ +0.1	P ±0.1	Po* ±0.1	P ₂ ±0.05	E ±0.1	F ±0.05	G	W ±0.3	₩0 ±0.2	K ±0.1	T ±0.1
Box size	20.1		20.1		-0	-0	20.1	20.1	10.00	20.1	±0.00		10.0	±0.2	20.1	20.1
4.8x 3.3x 2	3.55	3.3	5.1	4.8	Ø1.5	Ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	2.8	0.3
4.8x 3.3x 3	3.55	3.3	5.1	4.8	Ø1.5	Ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	3.4	0.3
4.8x 3.3x 4	3.55	3.3	5.1	4.8	Ø1.5	Ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	4.4	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk
1000	3000	1000
750	2500	1000
500	2000	1000

SMD 2220	A0 ±0.1	Aı	Bo ±0.1	Ві	Do +0.1	D1 +0.1	P ±0.1	Po* ±0.1	P ₂	E ±0.1	F ±0.05	G	W ±0,3	₩0 ±0.2	K ±0.1	T ±0.1
Box size	20.1		20.1		-0	-0	20.1	10.1	20.00	10.1	10.00		±0.0	±0.2	20.1	20.1
5.7x 5.1x 2.5	6.1	5.7	5.6	5.1	Ø1.5	Ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	2.8	0.3
5.7x 5.1x 3.5	6.3	5.7	5.6	5.1	Ø1.5	Ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	3.7	0.3
5.7x 5.1x 4.5	6.3	5.7	5.6	5.1	Ø1.5	Ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	4.7	0.3

taped Reel 180 mm Ø	taped Reel 330 mm Ø	bulk
800	3000	1000
500	1800	1000
400	1500	1000

SMD 2824	Ao ±0.1	Aı	Bo ±0.1	Ві	Do +0.1	D1 +0.1	P ±0.1	Po* ±0.1	P ₂ ±0.05	E ±0.1	F ±0.05	G	W ±0,3	₩0 ±0,2	K ±0.1	T ±0.1
Box size					-0	-0										
7.2x 6.1x 2	6.4	6.1	7.7	7.2	Ø1.5	Ø1.5	8	4	2	1.75	5.5	0.9	12	9.5	2.8	0.3
7.2x 6.1x 3	6.6	6.1	7.7	7.2	Ø1.5	Ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	3.4	0.3
7.2x 6.1x 4	6.6	6.1	7.7	7.2	Ø1.5	Ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	4.4	0.3
7.2x 6.1x 5	6.6	6.1	7.7	7.2	Ø1.5	Ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	5.4	0.4

taped Reel 330 mm Ø	bulk
3000	1000
1500	1000
1000	1000
750	1000

	A0 ±0.1	Aı	Bo ±0.1	Ві	Do +0.1 -0	D1 +0.1 -0	P ±0.1	Po* ±0.1	P ₂ ±0.05	E ±0.1	F ±0.05	G	₩ ±0.3	₩0 ±0.2	K ±0.1	T ±0.1
SMD 4030	10.7	10.2	9.7	9.1	Ø1.5	Ø1.5	16	4	2	1.75	7.5	1.9	16	13.3	5.9	0.3
SMD 4036	10.7	10.2	9.7	9.1	Ø1.5	Ø1.5	16	4	2	1.75	7.5	1.9	16	13.3	5.9	0.3
SMD 5040	13.2	12.7	12.1	11.5	Ø1.5	Ø1.5	16	4	2	1.75	11.5	4.7	24	21.3	7.0	0.3
SMD 5045	13.2	12.7	12.1	11.5	Ø1.5	Ø1.5	16	4	2	1.75	11.5	4.7	24	21.3	7.0	0.3
SMD 6054	17.0	16.5	15.6	15.0	Ø1.5	Ø1.5	20	4	2	1.75	11.5	2.95	24	21.3	7.5	0.3
SMD 6560	17.0	16.5	15.6	15.0	Ø1.5	Ø1.5	20	4	2	1.75	11.5	2.95	24	21.3	7.5	0.3

taped Reel 330 mm Ø	bulk				
775	500				
775	500				
600	200				
600	200				
450	200				
450	200				

^{*} cumulative after 10 steps ± 0.2 mm max. Samples and pre-production needs on request or 1 Reel minimum.